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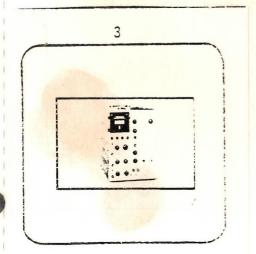


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LEAVE ON SCREEN

E.D COVER

On January 18th., Tekhouse introduced the most actuanced oscilloscope in the world today, On 1104 oscilloscope in the One Gighety real time oscilloscope with a vertical plug- in lens thorty of 10 milliolts per Charrier and a hory sweep sweep of 200 picoseconch per charrier.



In 1962 Tektrouse introduced the 519. This 1000 megherty oscilloscope of fered 10 volts vertical sensitivity and a sweep speed of 2 hanosecouch per during

Script Sheet Pages Date Draft Number 1 • 2 • Final Script Visual Concepts It had one distinct dis avantinge 100 LB weight. really a pertable instrument. This fact and its limited vertical sensitivity greatly limited its application 17 years after its introchection the 519 is Still windely used particularly in laser Technology unmer gence of the worlds thermo hucular.

powers in the early 60's to measure the power. of the atom. This instrument has fulfilled a veital role in Kigh prequency instrumentation needs of the Todays needs sequire a greater constiting and to meet this need Jek house has introduced the 7104 To clay we are going to look a two Important aspects descloped here a Lektiques to Oleveloped the Tio4 Ocalles cope.

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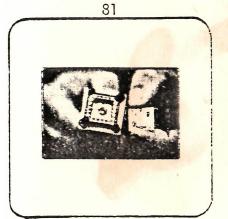
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unovation shile.

The key to our success at Tektiones to innevation . What we will how. look at is two fine examples of unovation



The first One will look at is its unique. C. RT.



and then the thin film hybrid technology developed at tekthenix fa. the Tion

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Script

as with all fund amental ideas there Must be an unherent under stand of the Physical laws of nature loe see such an escample of the physical laws in the development of the Mucro. Channel plate. This emque structure is one of the Major. Components of the Cathoole say tube used in the 7104

The M. o.C. P as the Micro channel plate 10 Called 10

The MCP is an assembled structure of Microscopic conductive glass channels. An electron entering a channel will produce secondary electrons as it strikes the channel walls. This process cascades thru the channel resulting in a multiplication of several hundred thousand times. It is this phenomena which gives the CRT its tremendous writing rate. Much in excess

of an. C. R.T. today

E.Don C.R.T.

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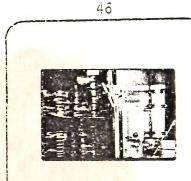
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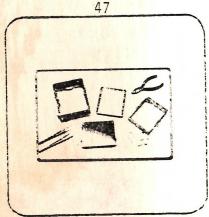
Photo. MULTIPLIER

Script The principal of election multiplication to not new. Here eve see the principal esoplained in a text published in 1945.

The MCP's are purchased from Galileo Electro optics. At TEK, they must be stored in special cabinets that are filled with dry nitrogen to keep out moisture and other contamination.



The entire inspection and assembly process of the faceplate must be done in a controlled clean room environment.



The first step of the assembly process is to inspect the MCP for cracks, blocked channels, and hole uniformity.





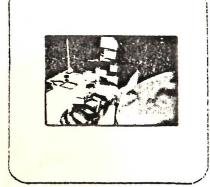


The MCP requires a special high tolerance mounting system which will place the plate exactly

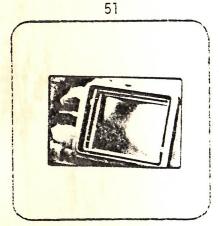
3 millimeters from the aluminized phosphor coating.



Spacing and mounting are critical since 700 to 1200 volts will be applied across the two surfaces of the plate.



The faceplate assembly is now completed and awaits joining to the CRT gun assembly.



Another major technological advancement introduced in the 7104 CRT is the meshless scan expansion lens, sometimes called the M.S.E. lens.



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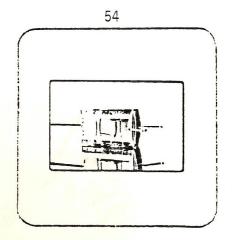
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Starting with a block of stainless steel  $4" \times 2.5" \times 1"$  and etching parts away, Conrad came up with a basic square shaped box that would expand the beam.

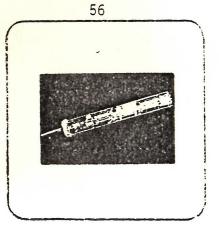


Within six months, the lens was refined to where it would successfully expand an electron beam scan to an 8 x 10 division display with no distortion or increase of spot size. Without a new type expansion lens, the CRT would have to be 7 feet long.



55

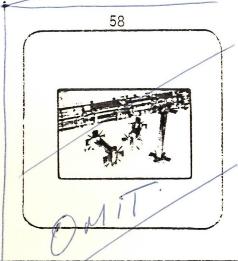
The final major portion of the new CRT is the gun assembly. The 7104 CRT uses similiar processes as other simpler CRT's but is much more complex.



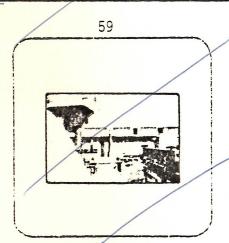
Distributed vertical deflection plates have been used in previous high frequency CRT's: First, the 519, more recently, the 7844 and 7904 CRT's. These distributed plates give the 7104 CRT approximately 3 Gigahertz capability and enables the 7104 to offer a 1 Gigahertz system bandwidth.



The 7104 takes distributed deflection one step further. For the first time, horizontal plates are also distributed. This allows linear sweep speeds to 200 picoseconds per division and extremely wide horizontal bandwidths for an X-Y measurement capability to 350 MHz.



Assembly of the gun is done in a fixture which maintains close tolerances and proper alignment.



Four glass rods are then fused to the gun ridigly holding the alignment of the gun structure. Here we get an excellent view of the vertical deflection plates in the rodded gun structure.

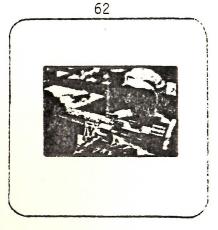


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glass envelopes will be sealed around the gun.

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The operator applies the heat and controls the rotation to maintain the proper speed.

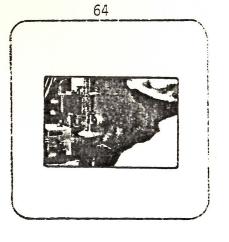


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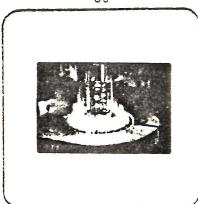
And, the glass envelopes are sealed together.



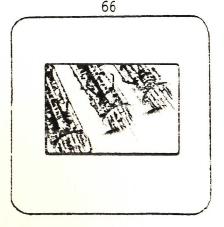
Molten glass is then applied to the base of the CRT.



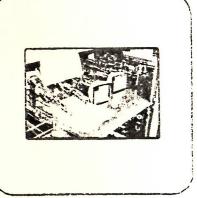
And, the neck pins are sealed off.



The stem protruding from the base will be used later to evacuate the air from the CRT.

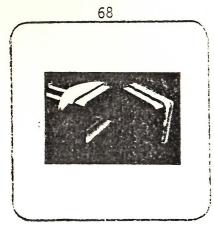


The finished gun assembly waits to be joined with the faceplate containing the micro channel plate.



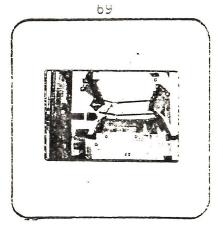
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To assemble both halves of the CRT, special metal flanges have to be used because the MCP cannot tolerate temperatures used with glass or ceramic processing. Tektronix has pioneered the development of ceramic CRT's and has also pioneered metal to ceramic and glass bonding.

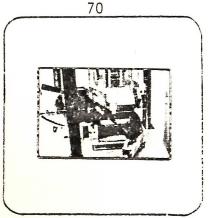




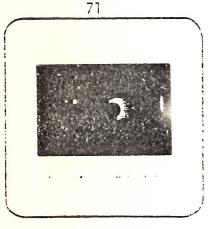
To complete the joining process, the upper and lower CRT halves are aligned in this special TEK designed heliarc fixture.



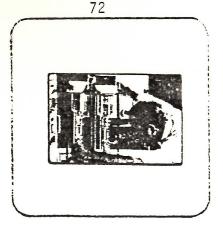
The copper plates maintain the critical alignment of the upper and lower flanges and act as heat sinks to protect the MCP.



The CRT is then rotated while the heliarc welds the joint.



The CRT is now complete and all gases will be evacuated. Here, Stan Prier places a tube on an oil diffusion vacuum pump with a dry nitrogen trap.





Because of the high moisture content of the MCP, it is necessary to vacuum pump the tube continuously for 24 hours as opposed to only 4 hours for other CRT's.



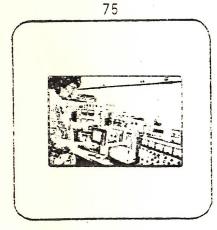
Up to this point, we can only assume a good CRT.

Only testing will tell. The tube must first be wired....



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And then mounted in a special text fixture.



This test set was designed to support testing of this special, highly complex CRT until a more automated test station can be installed.



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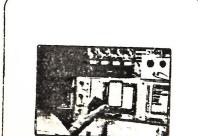
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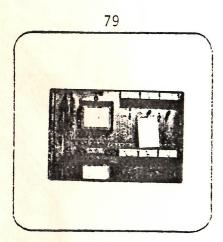
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After the CRT is successfully turned on for the first time, it is inspected for any operational defects.

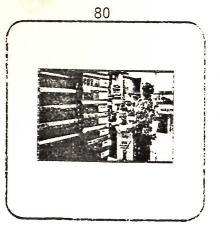


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After testing, the CRT's are aged for 24 hours to stabilize the gain on Micro Channel plates.



The tubes are then shipped to the 7104 manufacturing area for assembly into the finished product.



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E.D. FRONT COVER  SHOWING HYBRIDS	The thin film he at Jek thomas emble today.  We will look of an hybrid technic	ybud tech eraces som technology	
hypcon Connector	First the paten board Connector	ted Tekth alled the	enere Cerant Hypron
SHF. III DIE	heset one of Our process especially.  program known a	integrated evolved for our 5Hf	Circuito Little 7104  - III process
155-0176-00 Heybud	and fually to techniques	he hybrid	l assembly
hy poen connector	The hylon Cor important functi First it allow and its critical po signal thru the sy manner Se cond it allow or personal of the	s the sego is the sego is emeters to ystem in a	process the
A multi-image script sheet			Courtesy 3M Company

Page 15, of Script Sheet (),110 Pages to ? o Final Draft Number Visual Concepts Script Here we see an exploited view of eschloded view of the hycon Come ctor system. It should the hypcon system. be noted here that the hy con Connection has a V. S. W. R of better than 1.1 to Considerably better than most of the Ropular 3 m. m. Connectors and a paction of the Cost of such Connectors Here expee on our intergrated around DIE Clevice. In the form Here we see a cross section on the EID On SHFTIT Intergrated Circuit. The Case and as ene c clopped emitters are both lon unplanted for superior Cartrol of Coping Profile Shallow, repeatable Jemetrons are essential for hight fts, typically about

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/2 Clother and hybrics Script

The ther film technology at Jek trans (s a combination of Many specalised areas starting with Camputer graphus and mapping, advanced then film technology, laser technology, and acho anced assembly techniques Page 17 of Pages

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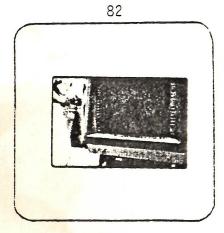
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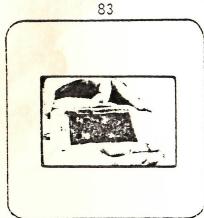
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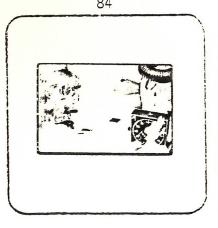
The artwork for the IC chip and the substrate is hand drawn and then computerized.



Filmwork is then made, and placed over a photoresistive coated plate of ceramic.



The photo resist is then exposed to light....



a montinuge stript succi

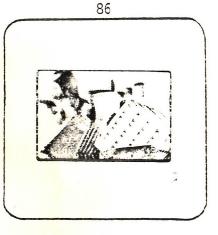
company on company

And the reamining material is then etched away.



This leaves the desired patterns on the ceramic.

These devices will then be laser scribed into individual substrates....



and are ready for the IC die attachment.



The IC's are picked up by vacuum.



And are attached to the ceramic substrate.



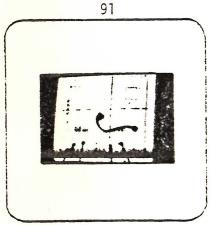
The wire bonding machine automatically forms, places, and welds the wires from the IC to the substrate.



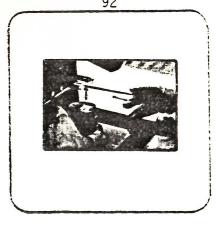
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These solid gold wires are extremely fine.

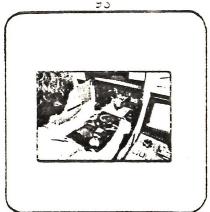
They are 1 mil. thick. The operator uses a microscope video system to ensure proper bonding.



The wire bonds are then pulled to check proper bonding strength.



The finished IC hybrid is then laser trimed by a YAG laser which moves across the hybrid....



and precisely etches away the resistive networks, leaving the proper values on the substrate.

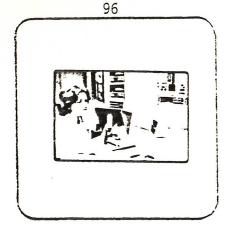


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The hybrid is now complete and ready for testing.



This 3260 system first checks the DC operating perameters of the hyrbid.



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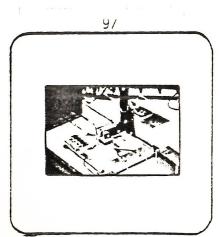
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Because of the high frequency nature of these devices, special fixtures must be used for dynamic testing.



They are tested for bandwidth and transient response.



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The devices are now shipped to the 7104 manufacturing line where they will be built into the many circuit boards....



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were they are least into

Jek Slide.

the shope you have an loyed this shide presentation of the T104 Oscilloscope thank you